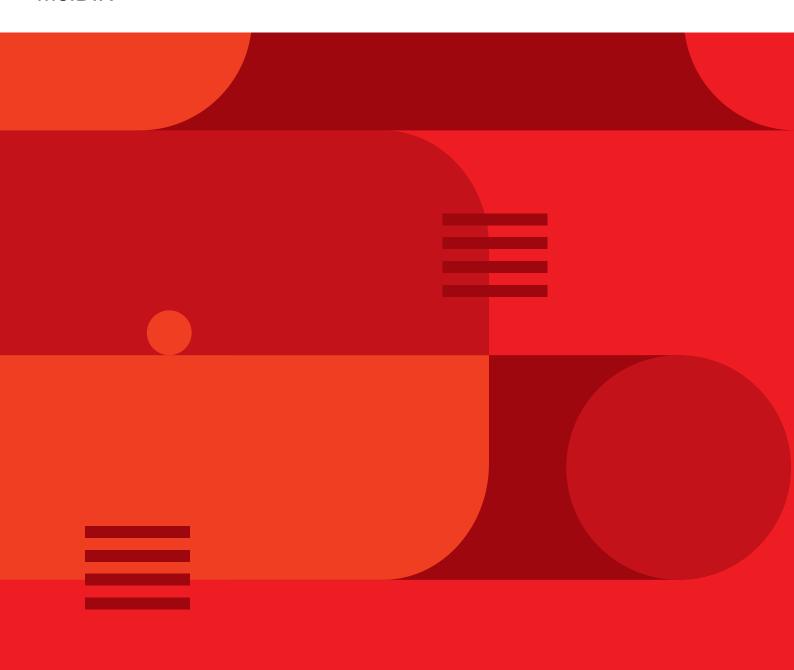


INFRARED SENSORS MelDIR



INFRARED SENSORS

Highly precise detection of people and objects using sensor technologies installed in satellites MeIDIR



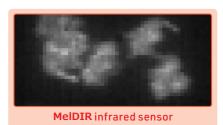






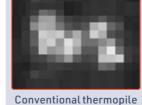


High pixel count and high temperature-resolution enable highly precise understanding of people/object movement



10µm Supporting Legs







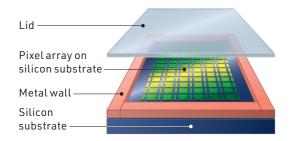
(16×16 pixels)

Mitsubishi Electric Original Pixel Structure

- 1) The supporting legs are ultrathin thanks to the introduction of an innovative microfabrication technique. This makes it possible to transfer energy more efficiently without releasing heat, thereby enabling the pixel count to be increased and achieving higher image
- 2) The generation of electromagnetic noise is minimized by mounting the thermal diode and high-performance amplifier on the same chip, achieving high temperature-resolution.



Vacuum-sealing, Chip-scale Packaging Contributes to Compact Space-saving Size



Vacuum-sealing, Chip-scale technology

- 1) Chip-scale packaging technology developed in-house eliminates the use of ceramic package and achieves vacuum state performance.
- 2) New packaging technology reduces product size to approximately 80% compared to conventional products*1, enabling greater compactness and space savings.
 - *1: Compared to general 16x16 pixel thermopiles available in market.

Specifications

	MIR8060 series		MIR8032 series
Туре No.	MIR8060B3*	MIR8060B1	MIR8032B1
Pixels	80 × 60 pixels	80 × 60 pixels	80 × 32 pixels
Field of View (FOV)	78° × 53° (тур.)	78° × 53° (Тур.)	78° × 29° (тур.)
Frame rate	4 / 8 fps (selective)	4/8 fps (selective)	4 fps (fixed)
Temp. resolution (NETD*2)	250 mK (Typ.)	100 mK (Typ.)	100 mK (Typ.)
Operating voltage	3.3 V	3.3 V	3.3 V
Current consumption	50mA (Max.)	50mA (Max.)	50mA (Max.)
Product dimensions	19.5 × 13.5 × 9.5 mm	19.5 × 13.5 × 9.5 mm	19.5 × 13.5 × 9.5 mm
Detectable temp. range	-5 °C ∼ +200 °C	-5°C∼+60°C	-5 °C ∼ +60 °C
Interface	Serial Peripheral Interface (SPI)	Serial Peripheral Interface (SPI)	Serial Peripheral Interface (SPI)

Application of Infrared Sensor

The following are possible areas of application for the Infrared Sensor. With the exception of HVAC, none of these applications have yet been tested and no products are currently under development or available for purchase. Accordingly, there are no claims are made as to the ability of the Infrared Sensor to achieve success in these applications.

Silhouette detection

(movement, posture, fever)

Both temperature and silhouette

Temperature measurement

Security

Detects intruders, etc.



- Detects posture
- Detects abnormal body surface temperature*

Measures room temperature Detects the position of

body surface temperature3



People count

Counts the number of people

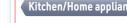


Care robot

- Detects behavior

Detects movement/ posture

Detects body surface temperature*



person

 Measures temperature of food being cooked Detects people



Raising livestock

 Measures surface temperature of livestock



Elevator/Escalator

Detects congestion



Toilets

 Detects abnormal movement/ posture



Bath

- Measures temperature
- Detects abnormal posture

Equipment monitoring

Monitors temperature



Detects the movement of people



 Detects people Measures temperature



- Measures body surface temperature*
- Detects gestures

Fire detection

- Detects possible fire outbreaks
- Detects people



Animal damage detection

Detects the presence of animal damage



Smart speaker

 Detects room temperature distribution and presence of people, and instructs various home appliances

Car cabin

 Detects presence of children Detects driver's possible condition

Health/beauty

 Measures body and face surface temperature* distribution



Home appliance

 Gesture-based operation



Factory safety/Electric fence

- Detects people
- Detects possible falls



Farm

Controls crop/environment temperature



*: This cannot be used for medical diagnosis.

Examples of use by Mitsubishi Electric (These products are available for purchase and use only in Japan.)



An infrared sensor has been fitted on the toilet monitoring system (kizkia-Knight T). This system monitors a user in the toilet in nursing care facilities, etc. while ensuring privacy.



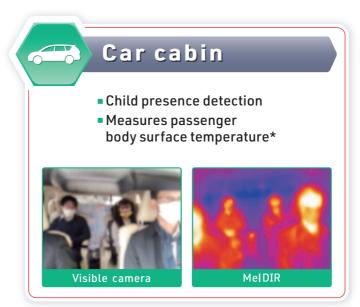
The i-See Sensor equipped with MelDIR features "Touch Airflow" which allows the user to adjust the airflow simply by touching the place where the user wants the airflow to be delivered while viewing the thermal image of the room on the user's smartphone.

*2: Noise Equivalent Temperature Difference ★: New Product

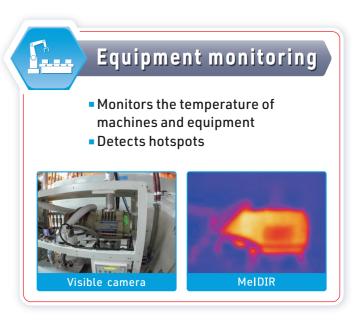
Infrared Sensor MeIDIR Thermal Images

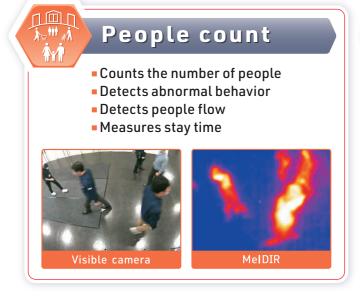


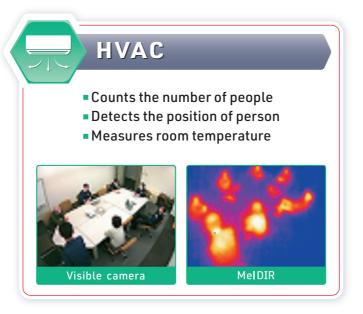


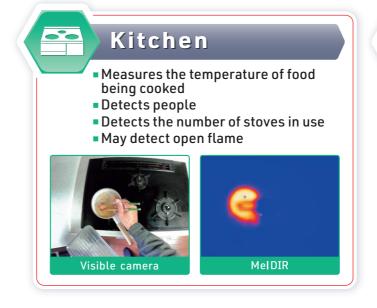


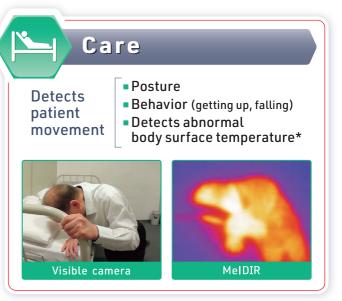
of the Infrared Sensor to achieve success in these applications.













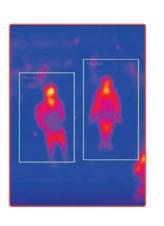
(AI)-

Infrared sensor MeIDIR × Deep Leaning

Provides a detection algorithm based on deep learning of AI that takes advantage of the features of infrared sensor MelDIR

Features

- Uses thermal imagery to protect privacy
- Since MelDIR detects human shape, it can detect with high accuracy even with a small amount of calculation
- System cost is reduced by edge AI that can operate with a general-purpose microcontroller

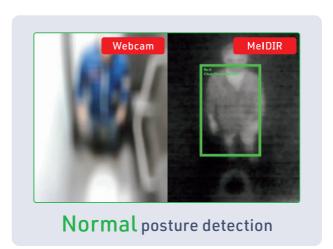


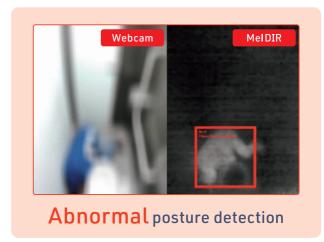
Detection example using deep-learning algorithm

[example of possible bathroom fall]

The following are possible areas of application for the Infrared Sensor. With the exception of HVAC, none of these applications have yet been

tested and no products are currently under development or available for purchase. Accordingly, there are no claims are made as to the ability





3

MEMO

User-support tools that contribute to reducing customer development time

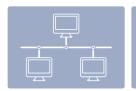
Product planning

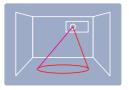
Technology development

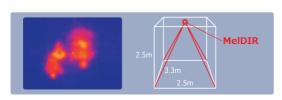
Product development

Proposal

Propose use for each application







System configuration

Installation example

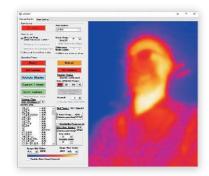
Monitoring example

Demo Kit

Provide hardware and image display software required to evaluate **MeIDIR**







Viewer

Reference Design

Software/hardware design support

Hardware information



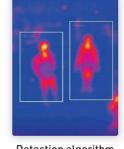
Gerber data



Software information



Reference cords



Detection algorithm (Learning of human/posture/action)

Documents



Application notes



INFRARED SENSORS MeIDIR

Mitsubishi Electric Infrared Sensors Website

www.MitsubishiElectric.com/semiconductors/infraredsensor/



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